

Dual P-channel MOSFET

ELM14805AA-N

■ General description

ELM14805AA-N uses advanced trench technology to provide excellent R_{d(on)} and low gate charge.

■ Features

- V_{ds}=-30V
- I_d=-8A (V_{gs}=-20V)
- R_{d(on)} < 18mΩ (V_{gs}=-20V)
- R_{d(on)} < 19mΩ (V_{gs}=-10V)

■ Maximum absolute ratings

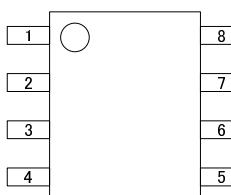
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V _{ds}	-30	V	
Gate-source voltage	V _{gs}	±25	V	
Continuous drain current	I _d	-8.0	A	1
		-6.9		
Pulsed drain current	I _{dm}	-40	A	2
Power dissipation	P _d	2.00	W	1
		1.44		
Junction and storage temperature range	T _j , T _{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	R _{θja}	50.0	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		73.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	R _{θjl}	31.0	40.0	°C/W	3

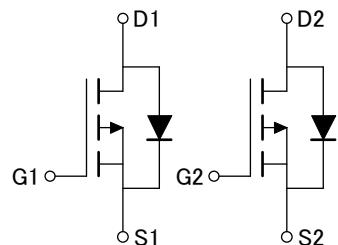
■ Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	$Id=-250\ \mu A, Vgs=0V$	-30			V
Zero gate voltage drain current	Idss	Vds=-24V			-1	μA
		Vgs=0V	Tj=55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±25V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-1.7	-2.5	-3.0	V
On state drain current	Id(on)	Vgs=-10V, Vds=-5V	-40			A
Static drain-source on-resistance	Rds(on)	Vgs=-10V		16.0	19.0	$m\Omega$
		Id=-8A	Tj=125°C	20.5	25.0	
		Vgs=-20V, Id=-8A		15.0	18.0	$m\Omega$
		Vgs=-4.5V, Id=-5A		33.0		$m\Omega$
Forward transconductance	Gfs	Vds=-5V, Id=-8A	16	21		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.75	-1.00	V
Max. body-diode continuous current	Is				-2.6	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz		2076	2500	pF
Output capacitance	Coss			503		pF
Reverse transfer capacitance	Crss			302		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		2	3	Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	Vgs=-10V, Vds=-15V Id=-8A		39.0	45.0	nC
Gate-source charge	Qgs			8.0		nC
Gate-drain charge	Qgd			11.4		nC
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Rl=1.8 Ω , Rgen=3 Ω		12.7		ns
Turn-on rise time	tr			7.0		ns
Turn-off delay time	td(off)			25.2		ns
Turn-off fall time	tf			12.0		ns
Body diode reverse recovery time	trr	If=-8A, dl/dt=100A/ μs		32	40	ns
Body diode reverse recovery charge	Qrr	If=-8A, dl/dt=100A/ μs		26		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

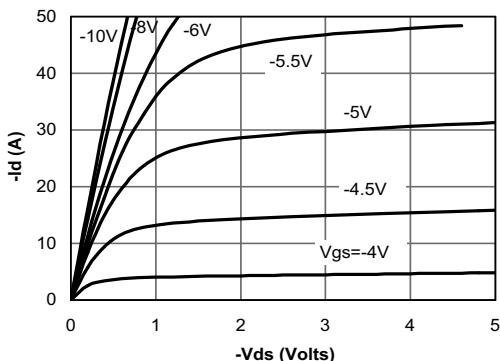


Fig 1: On-Region Characteristics

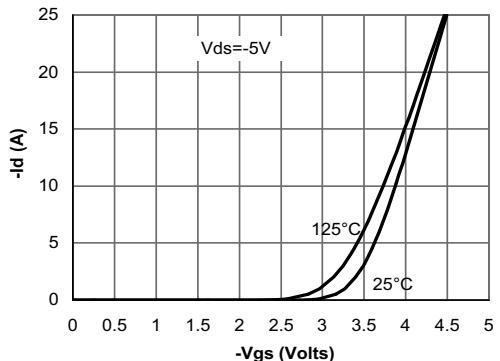


Figure 2: Transfer Characteristics

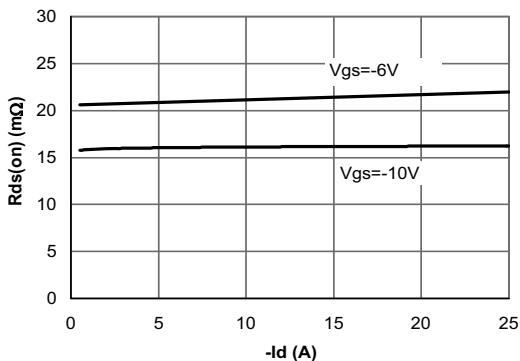


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

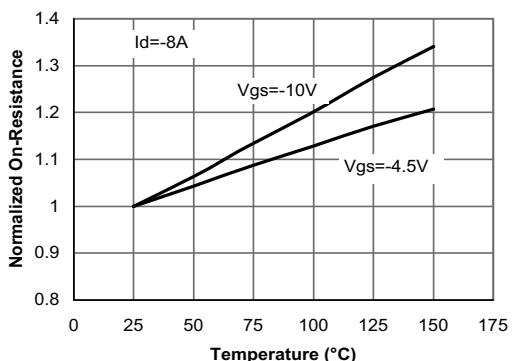


Figure 4: On-Resistance vs. Junction Temperature

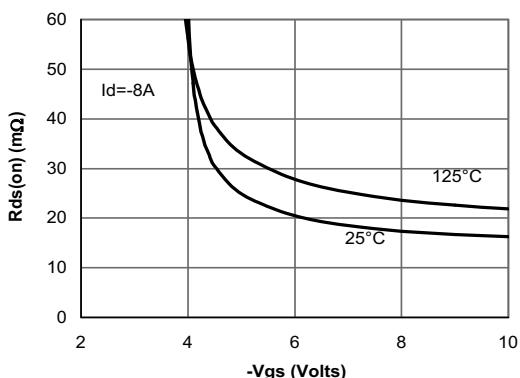


Figure 5: On-Resistance vs. Gate-Source Voltage

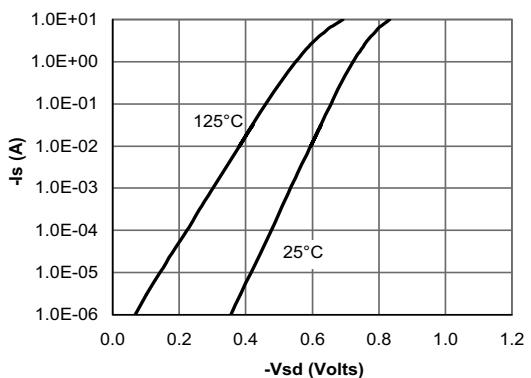


Figure 6: Body-Diode Characteristics

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